

Bid Bulletin No. 5

Consulting Service for the Updating of the Semiconductor and Electronics Industry Roadmap, and the Conduct of Feasibility Study on Establishing a Wafer Fabrication Plant Bidding No. 24-010

June 28, 2024

This Bid Bulletin No. 5 is hereby issued to modify or amend the Bidding Documents.

Terms of Reference

FROM	TO
Tatak Pinoy Industrial Policy (TIIP) Program	Tatak Pinoy Strategy (TPS) Program
Financial Arrangements and Payment Schedule (matrix – Output column) “Semiconductor and Electronics Roadmap”	Financial Arrangements and Payment Schedule (matrix – Output column) “Semiconductor and Electronics Industry Roadmap”

1. The Consultancy Firm shall have the option to engage the services of other key experts and may consider hiring additional experts.
2. The bidder is required to disclose allowable information (i.e., will not go against their confidentiality agreements with their clients), including the description/background of each of the bidder’s completed and ongoing projects.
3. The schedule of activity as follows:

Activity	Schedule
Technical Presentation	<p>10 July 2024, 10 A.M., for a Face-to-Face Technical Presentation.</p> <p>Maximum of 20 minutes for the presentation of the bidder.</p> <p>Venue: Makabayan Conference Room, 2/F, HPGV Building, 395 Sen. Gil J. Puyat Ave., Makati City.</p> <p>Contact Person: Ms. Grace Tangcangco or Ms. Maria Crispina Reodica</p>

For the guidance and information of all concerned.

SGD.
KRISTIAN R. ABLAN
Assistant Secretary
Chairperson, DTI Bids and Awards Committee

Conforme:

Name and Signature of
Authorized Representative
Date: _____

BIDS AND AWARDS COMMITTEE